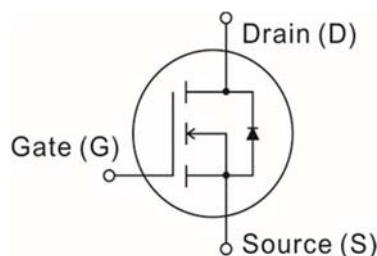


**Product Summary**

Parameter	Value	Unit
V_{DS} @ T_{jmax}	100	V
$R_{DS(on),max}$ @ $V_{GS} = 10$ V	5.0	mΩ
I_D @ $V_{GS} = 10$ V	130	A
P_{tot}	214	W

**Features**

- * Low on-resistance
- * Low gate threshold voltage
- * Excellent FOM

Application

- * Synchronous rectification
- * BMS battery protection
- * DC/AC inverter
- * DC/DC converter

Maximum ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain - source voltage	V_{DS}	100	V
Continuous drain current $T_c @ 25^\circ\text{C}$	I_D	130	A
		110	
Pulsed drain current tp limited by T_j max (Note 1)	I_D pulsed	420	A
Single pulse avalanche energy (Note 2)	E_{AS}	200	mJ
Gate-source voltage	V_{GS}	± 20	V
Power dissipation	P_{tot}	214	W
Storage temperature range	T_{STG}	- 55 to +175	°C
Operating junction temperature range	T_J	- 55 to +175	°C



100V N-Channel Power MOSFET

Electrical characteristics (TA = 25°C unless otherwise specified)						
Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Off characteristics						
Drain-source breakdown voltage	V _{GS} = 0V, I _D = 250uA	BV _{DSS}	100	---	---	V
Gate-source leakage	V _{GS} = ± 20V, V _{DS} =0V	I _{GSS}	---	---	± 100	nA
Zero gate voltage drain current	V _{DS} = 100V, V _{GS} = 0V, T _j =25°C T _j =125°C	I _{DS}	---	0.1	1	uA
On characteristics						
Drain-source on-state resistance	V _{GS} = 10V, I _D = 50A, T _j =25°C V _{GS} = 6V, I _D = 20A, T _j =25°C	R _{DS(on)}	---	4.3	5.0	mΩ
Gate-source threshold voltage	V _{DS} = V _{GS} , I _D = 250uA	V _{GS(th)}	1.5	2.0	2.5	V
Transecondtance	V _{DS} ≥2*I _D *R _{DS(on)} max, I _D =20A	g _{fs}	---	73	---	S
Gate resistance	F = 1MHz, open drain	R _G	---	0.31	---	Ω
Dynamic and switching characteristics						
Gate-source charge	V _{DD} = 50V, I _D = 50A V _{GS} = 0 to 10V	Q _{GS}	---	12	---	nC
Gate-drain charge		Q _{GD}	---	13	---	
Gate charge total		Q _G	---	50	---	
Turn-on delay time	V _{DD} = 50V, I _D = 30A V _{GS} = 10V, R _{G,ext} = 3Ω	T _{d(on)}	---	14	---	ns
Rise time		T _r	---	45	---	
Turn-off delay time		T _{d(off)}	---	30	---	
Fall time		T _f	---	12	---	
Input capacitance	V _{GS} = 0V, V _{DS} = 50V , F = 1MHz	C _{iss}	---	3300	4290	pF
Output capacitance		C _{oss}	---	540	702	
Reverse transfer capacitance		C _{rss}	---	40	---	
Drain-source diode characteristics and maximum ratings						
Inverse diode forward voltage	I _s = 50A, V _{GS} = 0V	V _{SD}	---	0.9	1.1	V
Reverse recovery time	V _R = 50V, I _F = 40A, di _F / dt = 100A / uS	t _{rr}	---	57	---	ns
Reverse recovery charge		Q _{rr}	---	111	---	nC
Peak reverse recovery current		I _{rm}	---	3.9	---	A

Notes:

1. Repetitive rating : pulsed width limited by maximum junction temperature.
2. V_{DD}=50V, starting T_j=25°C.

**Thermal characteristics**

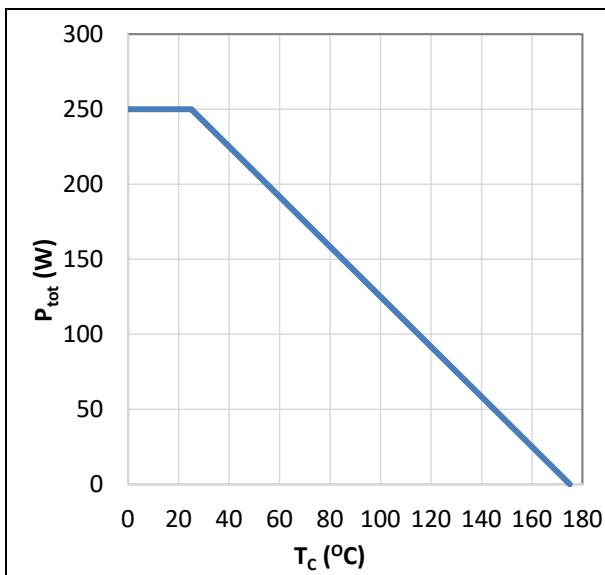
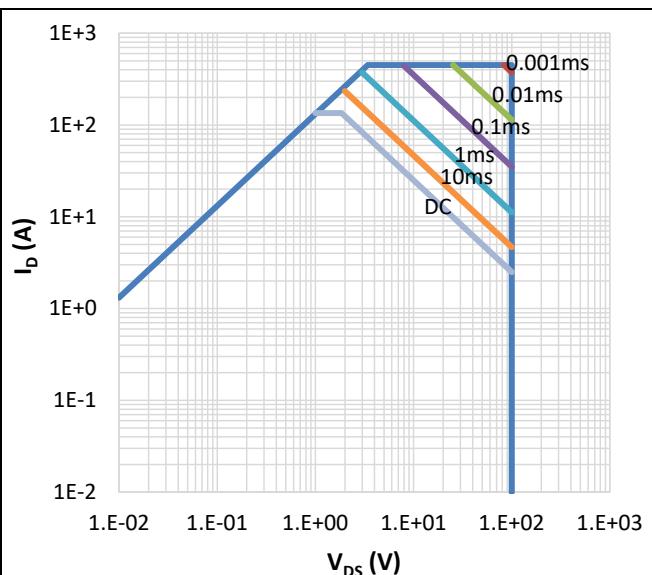
Thermal resistance junction-to-ambient	R _{thJA}	62	°C / W
Thermal resistance junction-to-case	R _{thJC}	0.70	

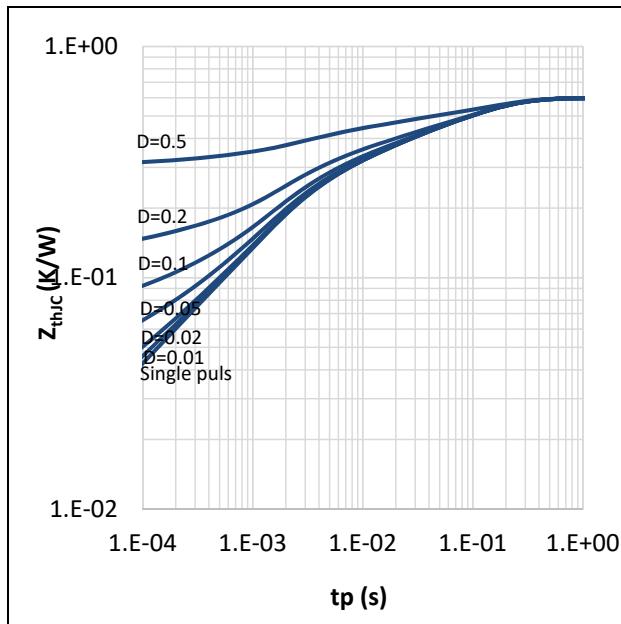
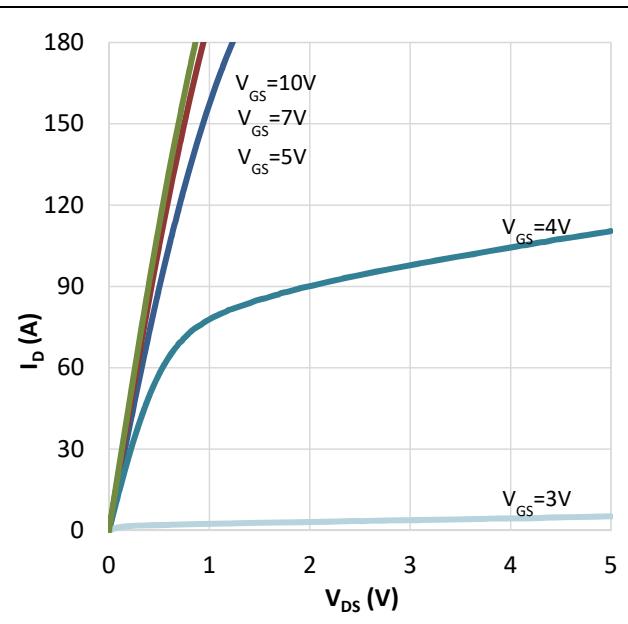
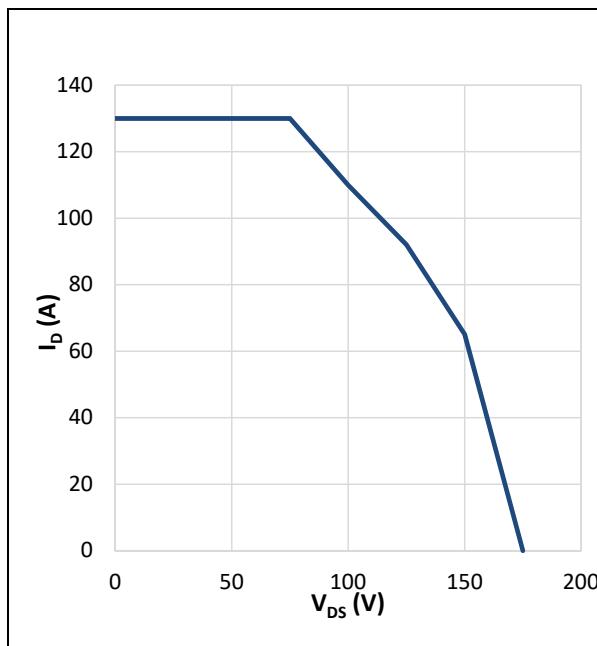
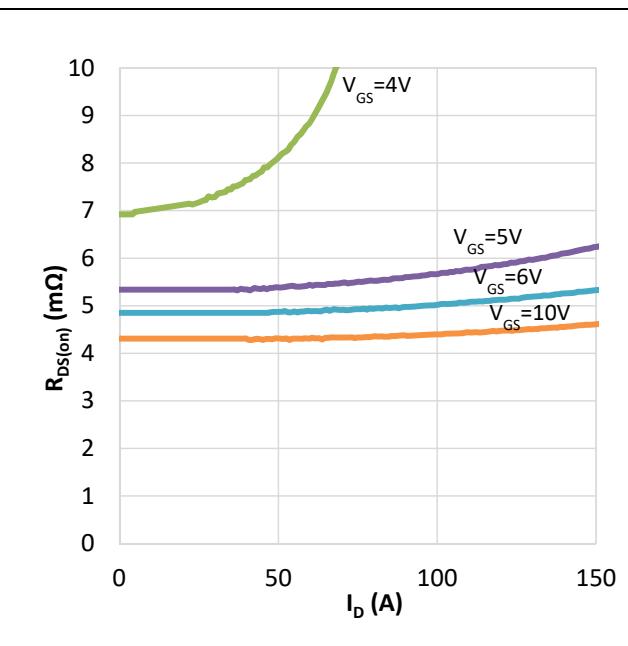
Package Marking and Ordering Information

Type / Ordering Code	Package	Packaging	Related Links
I3GT050N10	TO-220	Tube	see Package outline

Electrical characteristics diagrams**Fig 1: Power dissipation**

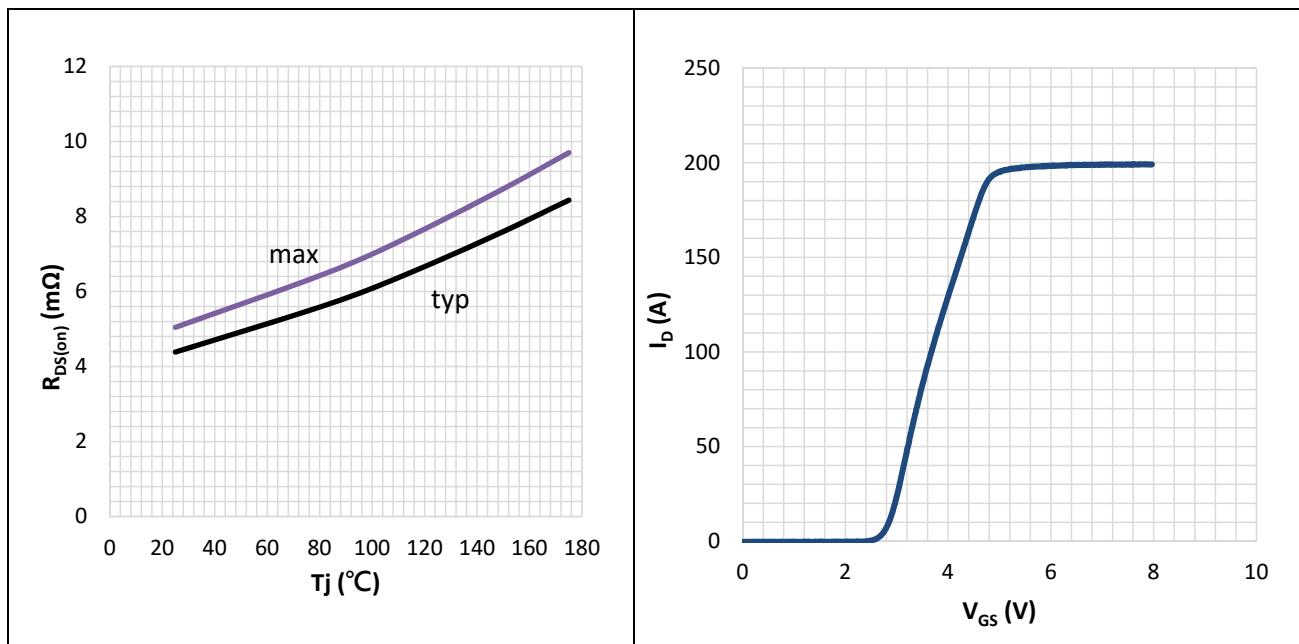
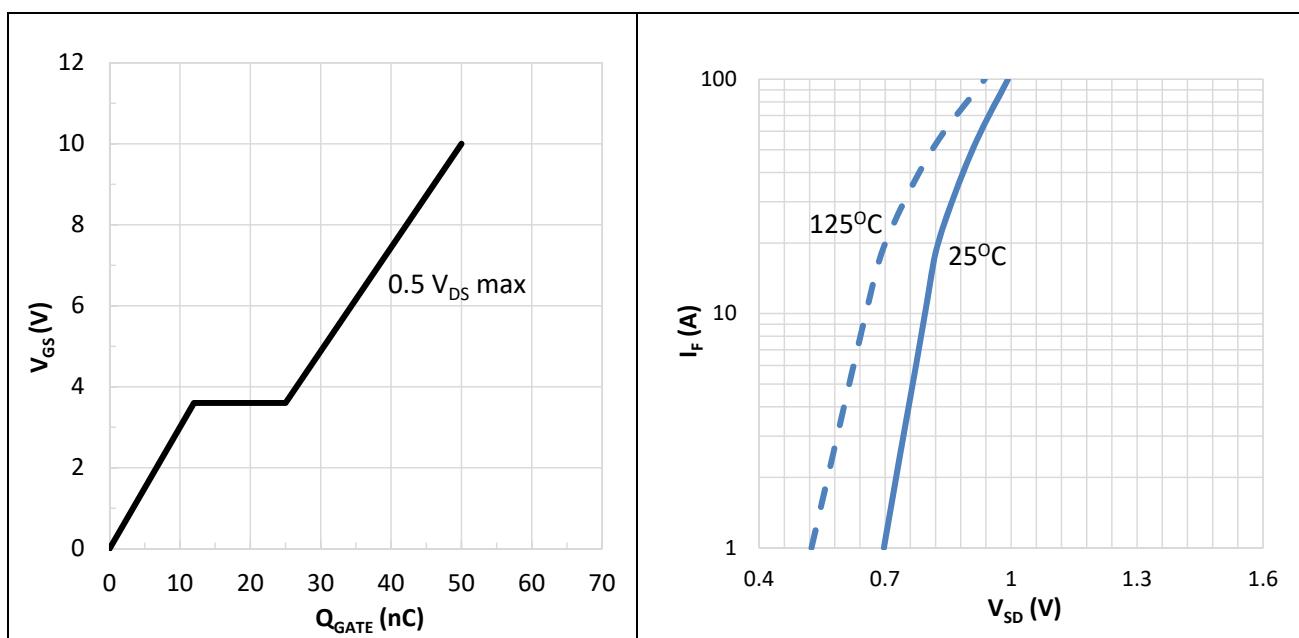
$$P_{\text{tot}} = f(T_c)$$

**Fig 2: Safe operating area**I_D = f (V_{DS}); parameter : D = 0, T_c = 25°C

**Electrical characteristics diagrams****Fig 3: Transient thermal impedance** $Z_{thJC} = f(tp); \text{ parameter : } D = tp / T$ **Fig 4: Typ. output characteristics** $I_D = f(V_{DS}); T_j = 25^\circ\text{C}; \text{ parameter: } V_{GS}$ **Fig 5: Drain current** $I_D = f(T_C); V_{GS} \geq 10\text{V}$ **Fig 6: Typ. Drain source on-resistance** $R_{DS(on)} = f(I_D); \text{ parameter : } tp = 50\mu\text{s}, T_j = 25^\circ\text{C}, V_{GS}$ 



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Fig 7: Drain-source on-state resistance $R_{DS(on)} = f(T_j)$; parameter : $I_D = 10A$, $V_{GS} = 10V$ **Fig 8: Typ. transfer characteristics** $I_D = f(V_{GS})$; $V_{DS} \geq 2 \times I_D \times R_{DS(on) \text{ max}}$; $T_j = 25^\circ C$; parameter : $t_p = 50 \mu S$ **Fig 9: Typ. gate charge** $V_{GS} = f(Q_{GATE})$; $I_D = 50A$ pulsed**Fig 10: Forward characteristics of body diode** $I_F = f(V_{SD})$; parameter : $T_j, t_p = 20\mu S$ 



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Fig 11: Drain-source breakdown voltage
 $V_{(BR)DSS} = f(T_j)$

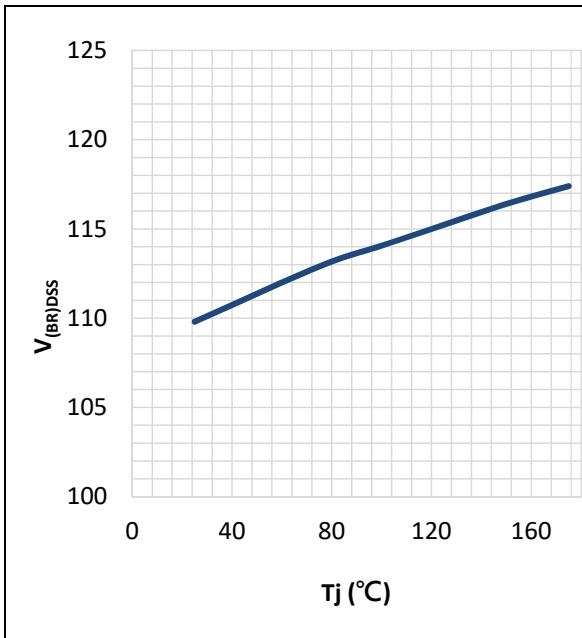


Fig 12: Typ. capacitances
 $C = f(V_{DS})$; parameter : $V_{GS} = 0V$, $f = 1MHz$

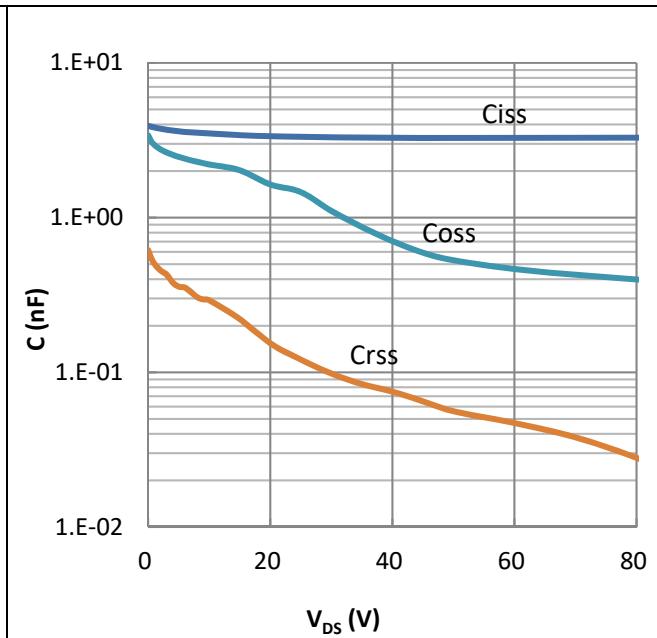
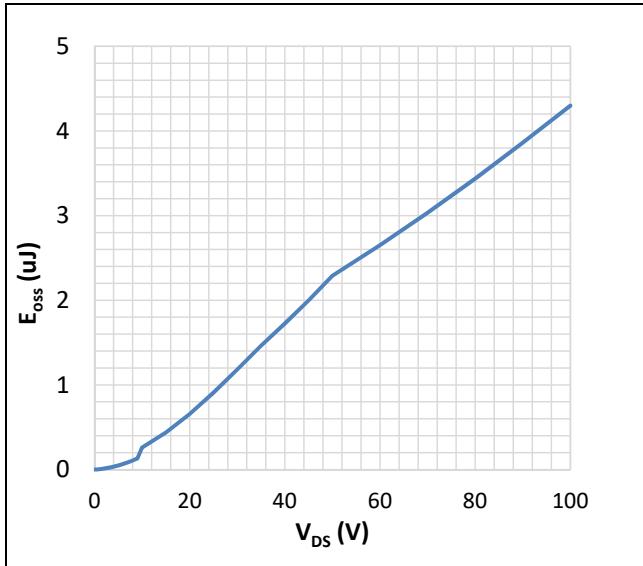
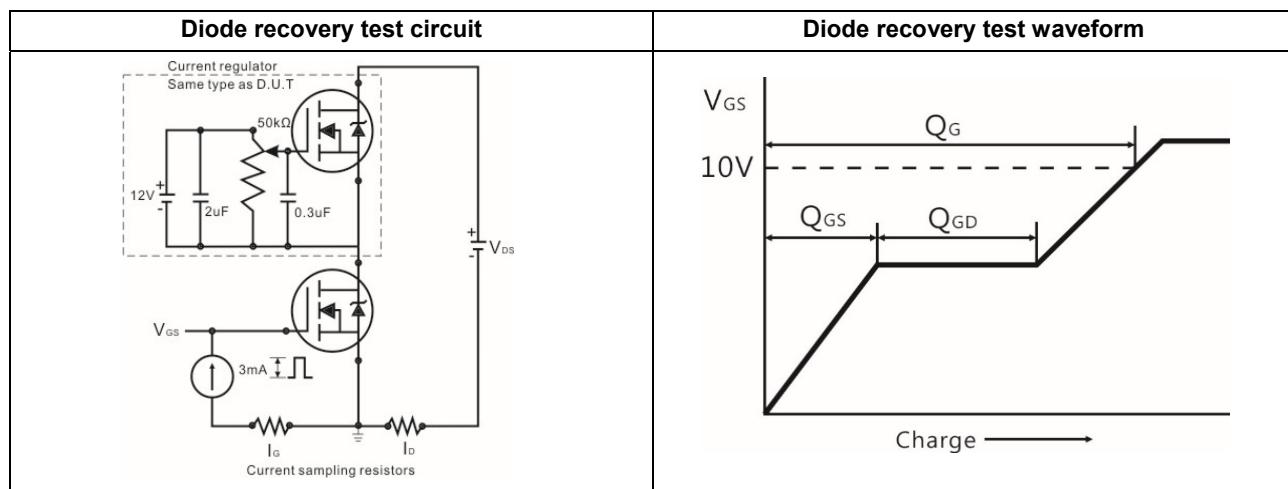
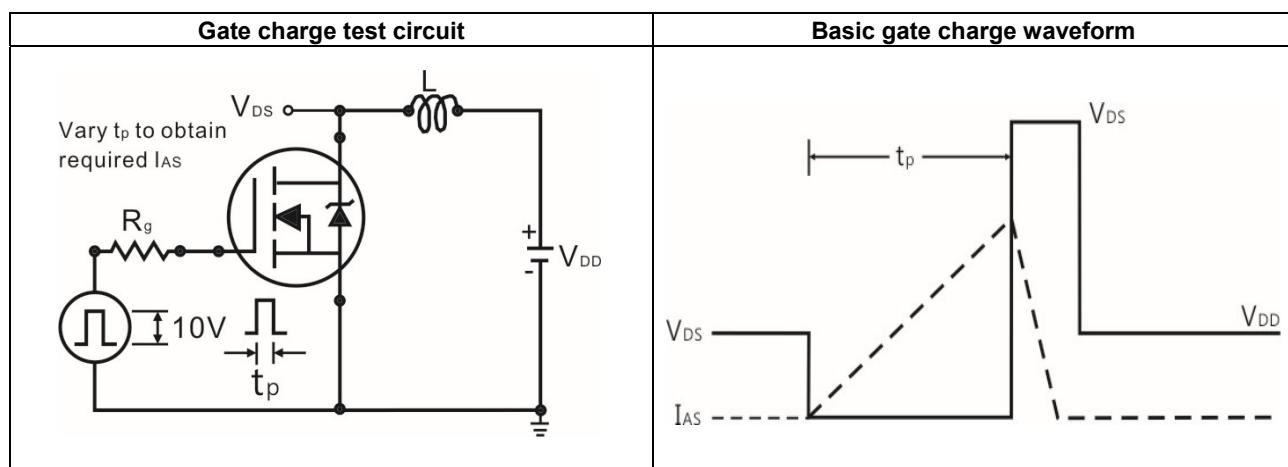
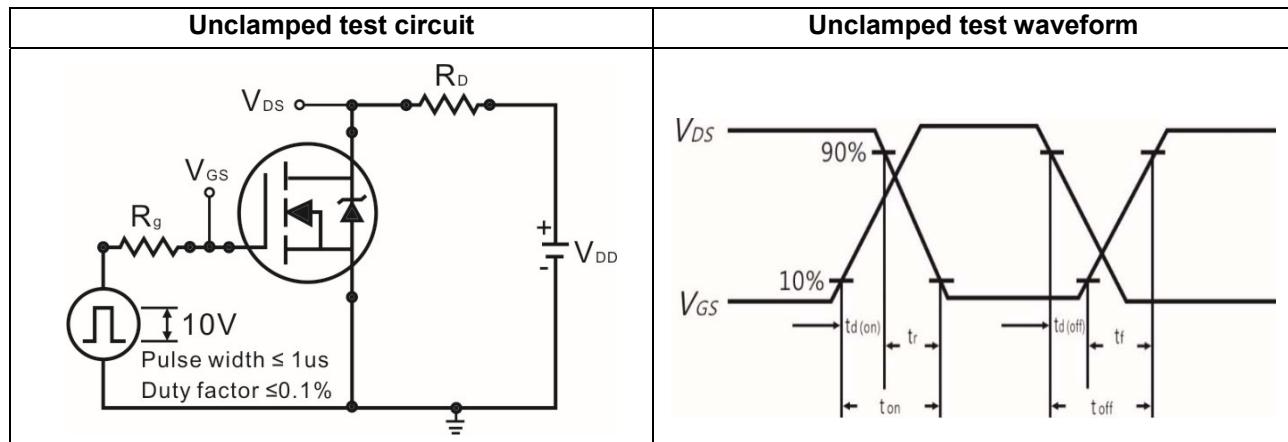


Fig 13: Typ. Coss stored energy
 $E_{oss} = f(V_{DS})$



**Test Circuit**



Package outline

TO-220-AB

